WNB111C5APTS

Hyperfast power diode - Bare die

29 October 2017

Product data sheet

1. General description

Hyperfast power diode bare die

2. Features and benefits

- Fast switching
- Low leakage current
- Low forward voltage drop
- Soft recovery characteristic
- Bare die

3. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_{RRM} *	repetitive peak reverse voltage			-	-	600	V
$I_{F(AV)}$ **	average forward current	δ = 0.5; square-wave pulse		-	-	15	A
Static characteristics							
V_F **	forward voltage	I_F = 15 A; T_j = 150 °C		-	1.4	2	V
Dynamic characteristics							
t_{rr} **	reverse recovery time	I_F = 1 A; V_R = 30 V; dI_F/dt = 200 A/µs; T_j = 25 °C		-	13	18	ns

4. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
WNB111C5APTS	Wafer	Bare die on wafer	Die

5. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{RRM} *	repetitive peak reverse voltage			-	600	V
V_{RWM} *	crest working reverse voltage			-	600	V
V_R *	reverse voltage	DC		-	600	V
$I_{F(AV)}$ **	average forward current	δ = 0.5; square-wave pulse		-	15	A
I_{FRM} **	repetitive peak forward current	δ = 0.5; t_p = 25 µs; square-wave pulse		-	30	A
I_{FSM} **	non-repetitive peak forward current	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse		-	180	A
		t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse		-	200	A
T_{stg} **	storage temperature			-65	175	°C
T_j **	junction temperature			-	175	°C

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6. Characteristics

Table 4. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Static characteristics							
V_F **	forward voltage	I_F = 5A; T_j = 25 °C		-	-	2.3	V
		I_F = 15 A; T_j = 25 °C		-	2.7	3.2	V
		I_F = 15 A; T_j = 150 °C		-	1.4	2	V
I_R	reverse current	V_R = 600 V; T_j = 25 °C		-	1	10	µA
		V_R = 600 V; T_j = 150 °C		-	-	1	mA
Dynamic characteristics							
t_{rr} **	reverse recovery time	I_F = 1 A; V_R = 30 V; dI_F/dt = 200 A/µs; T_j = 25 °C		-	13	18	ns
		I_F = 15 A; V_R = 400 V; dI_F/dt = 500 A/µs; T_j = 25 °C		-	22	-	ns
		I_F = 15 A; V_R = 200 V; dI_F/dt = 200A/µs; T_j = 25 °C		-	28	-	ns

Notes:

(1) * mean that parameter are 100% test at T_{amb} = 25°C

(2) ** means that the guaranteed ratings and parameter limits will depend on the assembled structure. When correctly assembled with suitable die bonding and wire bonding, the device will have ratings and characteristics guaranteed in this data sheet, similar to the assembled devices such as BYC15-600P.

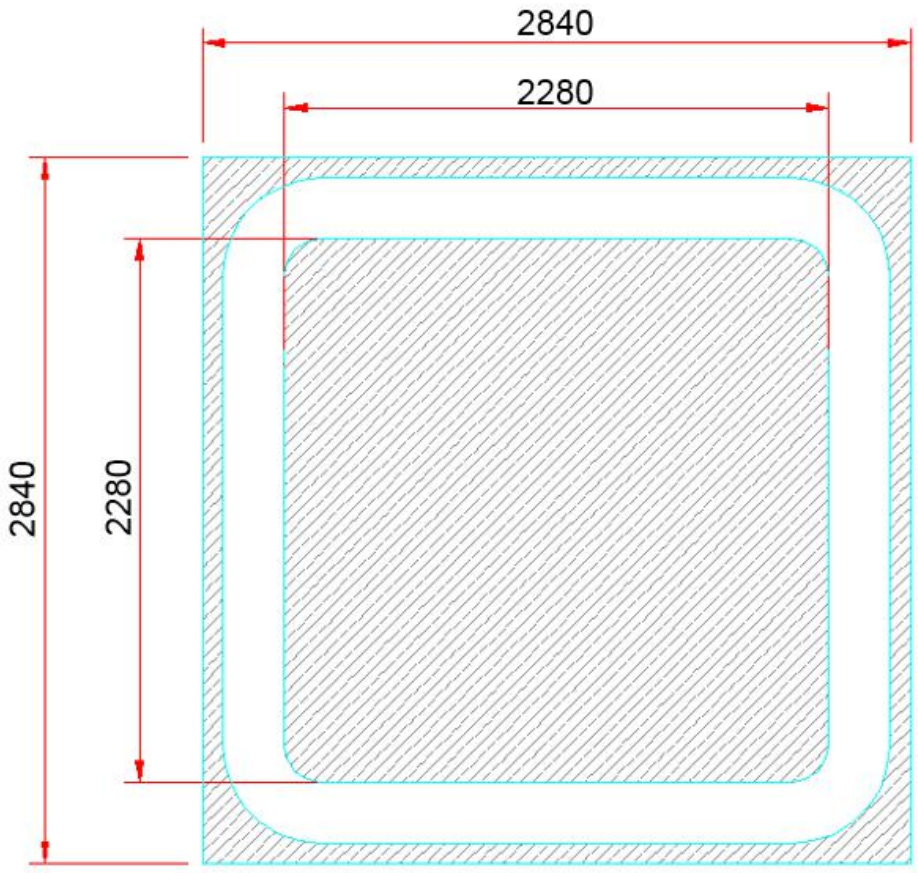
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MECHANICAL PARAMETER

Chip size	2.84 x 2.84	mm^2
Anode pad size	2.28 x 2.28	mm^2
Area total /active	8.07 / 5.20	mm^2
Thickness	300	µm
Wafer size	125	mm
Max possible chips per wafer	1371	pcs
Passivation	Glass	
Front metal	Al	
Back metal	Ti Ni Ag	

CHIP LAYOUT



Die size: 2840um x 2840um
Bond pad size: 2280um x 2280um

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7. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".
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8. Contents

1 General description 1
2 Features and benefits 1
3 Quick reference data 1
4 Ordering information 1
5 Limiting values 2
6 Characteristics 3
7 Legal information 5
8 Contents 7

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